



ECS02 / ECS03 / ECS05 Chip Shunt Resistors

Our ECS02 model exhibits a constant power 3W max. and continuous current of 100A at $0.3m\Omega$. The ECS03 model exhibits 5W max. and 100A at $0.5m\Omega$. The ECS05 exhibits a 10W max. and 220A at $0.2m\Omega$. These models have heavy high conductivity copper connectors, excellent long term stability and low inductance.



Applications include: Current sensors for hybrid power sources, frequency converters and high current automotive applications.

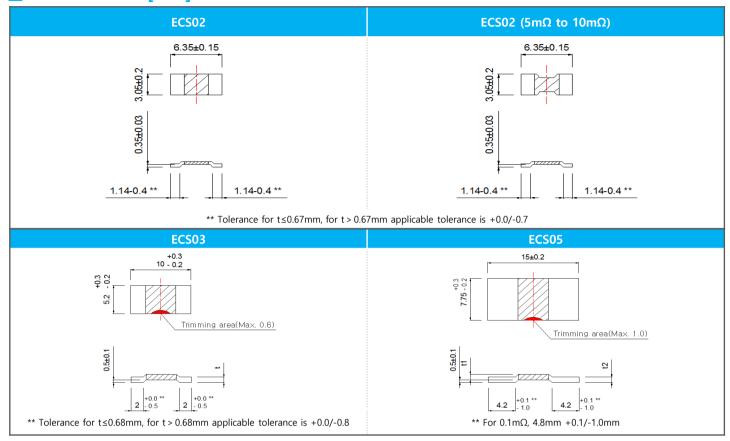
■ GENERAL SPECIFICATIONS

Model	Resistance Value [mΩ]	Power (@100°C) [W]	Power (@70℃) [W]	Material	Thickness (t)	TCR (ppm/°C)	Tolerance
ECS02	0.3	3.0	6.0	CM4	0.95mm±0.1	< 175	
	0.5	3.0	6.0	CM2	0.85mm±0.1	< 120	
	1.0	3.0	5.0	CM2	0.42mm±0.1	< 100	
	1.3	3.0	5.0	CM2	0.33mm±0.1	< 100	F [±1%]
	2.0	3.0	5.0	AC	0.67mm±0.1	< 50	C [1 20/1
	3.0	2.0	4.0	AC	0.45mm±0.1	< 50	G [±2%]
	4.0	2.0	3.0	AC	0.33mm±0.1	< 50	J [±5%]
	5.0	1.5	2.5	AC	0.33mm±0.1	< 50	
	6.8	1.5	2.0	AC	0.33mm±0.1	< 50	
	10.0	1.0	1.5	AC	0.33mm±0.1	< 50	
Model	Resistance Value [mΩ]	Power (@100℃) [W]	Power (@70℃) [W]	Material	Thickness (t)	TCR (ppm/°C)	Tolerance
	0.2	5.0	12.0	CM4	1.42mm±0.1	< 100	
	0.3	5.0	10.0	CM2	1.42mm±0.1	< 150	
	0.5	5.0	10.0	CM2	0.84mm±0.1	< 70	
	0.7	5.0	8.0	CM2	0.60mm±0.1	< 60	
ECS03	1.0	4.0	7.0	CM2	0.42mm±0.1	< 50	F [±1%]
	1.5	4.5	7.0	AC	0.91mm±0.1	< 50	
	2.0	4.0	6.0	AC	0.68mm±0.1	< 50	J [±5%]
	2.5	3.5	5.0	AC	0.54mm±0.1	< 50	
	3.0	3.0	5.0	AC	0.45mm±0.1	< 50	
	4.0	3.0	5.0	AC	0.34mm±0.1	< 50	
	5.0	2.0	3.0	AC	0.27mm±0.1	< 50	
Model	Resistance Value [mΩ]	Power (@100℃) [W]	Power (@70℃) [W]	Material	Thickness (t)	TCR (ppm/°C)	Tolerance
	0.1	10.0	15.0	CM4	1.42mm±0.1	< 300	
ECS05	0.2	10.0	15.0	CM2	1.40mm±0.1	< 200	
	0.25	8.0	10.0	CM2	1.12mm±0.1	< 200	
	0.3	7.0	10.0	CM2	0.93mm±0.1	< 175	
	0.4	6.5	9.0	CM2	0.72mm±0.1	< 175	F [±1%]
	0.5	6.0	8.0	CM2	0.56mm±0.1	< 175	
	0.6	6.0	8.0	CM2	0.47mm±0.1	< 175	J [±5%]
	1.0	6.0	9.0	AC	0.91mm±0.1	< 75	
	2.0	4.0	7.0	AC	t1:0.46mm±0.1 t2:0.70mm±0.1	< 75	
	3.0	3.0	5.0	AC	t1:0.31mm±0.1 t2:0.50mm±0.1	< 75	

* AC : Aluchrom Alloy, CM2 : Copper Manganese Alloy, CM4 : Copper Manganese Tin Alloy



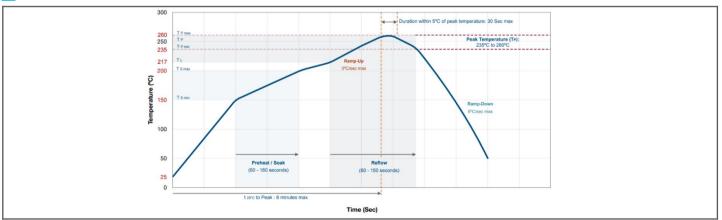
DIMENSIONS [mm]



SOLDER PAD LAYOUT

Model	Dimensions(mm)		
Model	LI	L2	w
ECS02	7.0	3.4	3.4
ECS03	11.0	5.6	6.2
ECS05	16.0	5.6	8.75

RECOMMENDED SOLDER REFLOW PROFILE



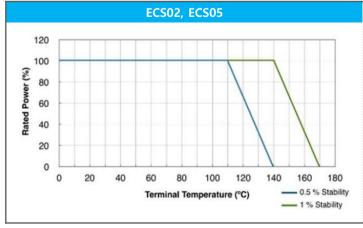


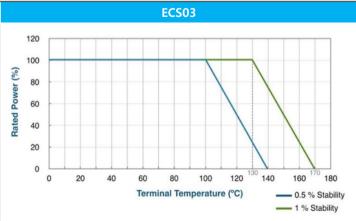


CHARACTERISTICS

	ECS02, ECS03	-55℃ ~ +170℃		
Operating Temperature Range	ECS05	-65℃ ~ +170℃		
	ECS02	< 2nH		
Inductance	ECS02 ECS03, ECS05	< 3nH		
	EC303, EC303			
Stability Deviation	ECS02, ECS05	< 0.5% after 2000hours (Terminal temp. < 110° C) < 1.0% after 2000hours (Terminal temp. < 140° C)		
Stability Deviation	ECS03	< 0.5% after 2000hours (Terminal temp. < 100°C) < 1.0% after 2000hours (Terminal temp. < 130°C)		
High Temperature Exposure	△R ±1.0%	1000 hours. @T=170°C. Unpowered.		
Temperature Cycling	△R ±0.5%	-55°C to 150°C, 1000cycles, 30minutes at each extreme.		
Biased Humidity	△R ±0.5%	85℃ & 85RH with 10% operating power, 1000hours.		
Operational Life	△R ±1.0%	125℃ at rated power, 1000hours.		
External Visual	Visual	Visual inspection.		
Physical Dimension	Shall confirm within tolerance limits	Dimensional inspection as per SBCL Specifications.		
Resistance to Solvents	Marking shall be legible	Clean with Aqueous chemical.		
Mechanical Shock	△R ±0.2%	100g for 6ms, Half sine.		
Vibration	△R ±0.2%	5g for 20minutes, 12cycles each of 3orientations. 10-2000Hz.		
Resistance to Soldering Heat	△R ±0.5%	Solder temperature 260°C, time 10seconds.		
Solderability	> 95% Coverage in 10×Magnification	As per J-STD-002.		
Electrical Characterization	Shall confirm within tolerance limits	Resistance as defined.		
Short Time Overload	△R ±1.0%	5×Rated power for 5seconds.		
Low Temperature Storage	△R ±0.2%	-65℃ for 24hours.		

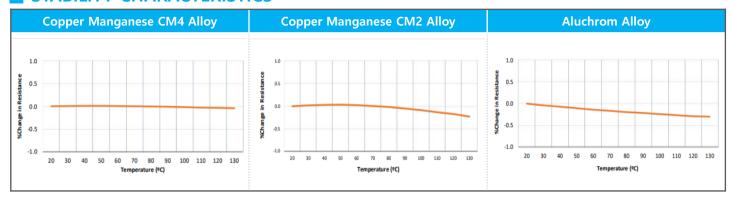
DERATING CURVE







STABILITY CHARACTERISTICS



PACKING SPECIFICATIONS



ORDERING PROCEDURE EXAMPLE

